



# Product Change Notification

## 102932 - 00

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# Product Change Notification

**Change Notification #:** 102932 - 00  
**Change Title:** Intel® 845PE, PCN 102932-00, FFF, 845PE B0 to B1 Stepping Conversion  
**Date of Publication:** November 20, 2002

## Type of Change Notification:

FFF - (Form-Fit-Function)

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

<b>Date of Samples Availability:</b>	Dec 16, 2002
<b>Date of Qualification Data Availability:</b>	Jan 06, 2003
<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	Feb 10, 2003
<b>Date of First Availability of Post-Conversion Material:</b>	Feb 10, 2003

*The date of "First Availability of Post-Conversion Material" is the projected date that a customer may expect to receive the Post-Conversion Materials. This date is determined by the projected depletion of inventory at the time of the PCN publication. The depletion of inventory may be impacted by fluctuating supply and demand, therefore, although customers should be prepared to receive the Post-Converted Materials on this date, Intel will continue to ship and customers may continue to receive the pre-converted materials until the inventory has been depleted.*

## Description of Change to the Customer:

The Intel® 845PE chipset component is converting from B0 to B1 stepping.

For technical details of the Intel® 845PE chipset component, please refer to the latest Spec Update available on FDBL.

## Customer Impact of Change and Recommended Action:

The 845PE B1 is pin-to-pin compatible with the B0 and does not require any motherboard modifications. Design changes have been made to the 845PE B1 and will require customers to perform re-qualification.

Please see the latest 845G BIOS Spec Update for any BIOS changes required for the B1 stepping.

## Products Affected / Intel Ordering Codes:

### Component Product Table

Pre-Conversion Product Code	Pre-Conversion Spec/ROM	Pre-Conversion MM#	Post-Conversion Product Code	Post-Conversion Spec/ROM	Post-Conversion MM#
			RG82845PE	Q D75	850152
RG82845PE	S L6H5	848621	RG82845PE	S L6Q3	850146

## Reference Documents / Attachments:

Document:

Location #:

## PCN Revision History:

Date of Revision:

November 20, 2002

Revision Number:

00

Reason:

Originally Published PCN